



DISCRIPTION

FEATURES

Molded construction Heat Resistance Molded Resin Excellent Mechanical Strength Excellent Solderability High Reliability Low Profile

OPTIONS

Tape & Reel is Standard (Qty: 5000 Pcs) Bulk Packing Available for smaller quantites Tolerance: J = 5% and K=10% is Standard, tighter Tolerance available (MOQ on request)

APPLICATIONS

VCRs DC/DC Converts Video Cameras CTV, VCR HIC Communication System Automotive Systems LCD/PDP Televisions Hard Disk Drives Network Systems Computer Peripheral Equipment

PHYSICAL CHARACTERISTICS

- Testing : (Equivalents acceptable) Inductance : HP4285A RDC : QuadTech 1880 m Ω Q : HP4342A SRF : HP4291A
- IDC Max : Determined when superimosed DC current is decreased 10% against it's initial value
- Operating Temperature : -40°C ~ +105°C
- Storage Temperature : -40°C ~ +105°C
- Solder methods : Vapor Phase, Infrared Reflow
- Resistance to soldering heat : 260°C for 10 seconds
- Solvent resistance : Conforms to MIL-STD-202E
- Marking : Inductance & Tolercane

ELECTRICAL SPECIFICATIONS

Properties	Test conditions		Value	Unit	Tol.
Inductance		L	5,6	μH	see Site 2
Q factor		Q	10		min.
DC-resistance		DCR typ.		Ω	typ.
DC-resistance		DCR max.	0,130	Ω	max.
Self-Res. Freq.		SRF	26	Mhz	min.
Test-Freq.			7,96	Mhz	
Rated Current		IDC	880	mA	max.
Saturation Current		Isat		mA	typ.

I. This electronic component is meant to be used in general electronic equipment. Before the incorporation of this component into any equipment with higher and more reliable requirements such as aviation, aerospace, submarine, nuclear control, transportation, transportation signal, disaster prevention, medical, public information network, etc. or if there is a possibility of injuries or damages to the human body, Edcon						CHIP INDUCTORS		
-Components must be informed before the stage of design-in. Evaluation checks for safety have to be performed on each electronic components used in electrical circuits that require high safety and reliability						Part No.:	S14	4004-5R6
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DRW:	Chang	CHKD	Young	MATL:	Chu Chi	DATE		10.06.2009
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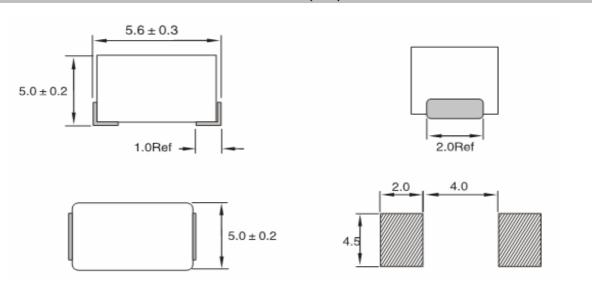
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TECHNICAL INFORMATIONS

Dimensions (mm)



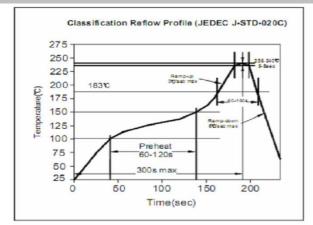
Ordering Information

Serie and Range

S14004-5R6

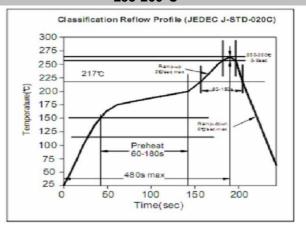
Tolerance	ROHS	Packing		
	-			
Κ	R	TR		
J = 5%	R = ROHS	BU = Bulk Ware		
K = 10%	N = non ROHS	TR = Tape Reel		
M = 20%				

Soldering Profile for Lead Free Soldering 235-240°C



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Soldering Profile for Lead Free Soldering 255-260°C



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